ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoc nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	level p	arts, the	declaratio	n encom	passes a	all lower	level mate	erials for	which th	eitem is an assembly e manufacturer has eclaration.	
1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175x								Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informa							
Supplier Information																
Company Name *	Company Unique ID		Unique ID Au	Response Date *			R	esponse	e Docum	nent ID						
SEMTECH CORPORATION	00-847-9941		DUNS	2022-0	3-08											
Contact Name *		Title - Contact		Phone - Cor	Email - Contact *					P 4	2	A (1				
Julie Vargo		Customer/Document	Control S	805-498-211	jvargo@semtech.com				Dup	olicate	Contact	-> Autho	orized Re	presentative		
Authorized Representative *		Title - Representative	е	Phone - Rep	Email - Representative *			* S	Supplier Comments or URL for Additional Information							
Julie Vargo		Customer/Document	t Control S	805-498-211	jvargo@semtech.com											
Requester Item Number		Mfr Item Number		Mfr Item Name	Effectiv	e Date	Version Manufa		rfacturing Site		Weight *	UC	OM	Unit Type		
		SX1262IMLTRT		Long Range,	<b>3</b>			Malaysia		4	44	mg	]	Each		
Alternate Recommenda	ation	tion			Alternate Item			Item Com	nments	'						
Manufacturing Proces	ss In	formation														
Terminal Plating / Grid Array Material Termina			Terminal B	ase Alloy	ting Peak Process Body Temp			Temperat	rature Max Time at Peak Temp			perature	perature Number of Reflow Cycles			
Matte Tin (Sn) - annealed C			CU Alloy				:	<b>260</b> C		<b>30</b> Se		econds	3			
Comments			!													
SX1262IMLTRT is REAC	Н-со	mpliant product, per	r EU Regu	lation EC190	7/2006 to include	the m	ost recer	t additio	on of SV	HC can	didate li	ist of sub	stances	s. ck/jv		

Save the fields in Import fields from a Clear all of the Lock the fields on this **Export Data** Import Data Reset Form Lock Supplier Fields this form to a file file into this form fields on this form form to prevent changes **RoHS Material Composition Declaration Declaration Type \*** Detailed Rohs Directive Rohs Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenvls (PBB). Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium 2002/95/EC Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a ?RoHS restricted substance?) in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier?s liability and the Company?s remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply. 1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance \* Accepted **RoHS Declaration \*** Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. **Declaration Signature** 

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## **Homogeneous Material Composition Declaration for Electronic Products**

**Subltem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

	Item/SubItem		Homogeneous	Weight	Unit of		Level	Substance Category			Substance	CAS	Evomet	Weight	Unit of Measure	Tolerance		PPM
	Name		Material	weight	Measure		Levei	Substance Category			Substance	CAS	Exempt			-	+	PPIVI
+1 -1	Die	+M -M	Silicon Chip	2.89	mg	+C -C	Supplier		+S	-S	Si	7440-21-3		2.89	mg		(	65,604
+1 -1	Mold Compound	+M -M	G770H	19.26	mg	+C -C	Supplier		+S	-S	Epoxy Resin A	Trade Secre		0.58	mg			13,130
		_							+S	-S	Epoxy Resin B	Trade Secre		0.58	mg			13,130
									+S	-S	Phenol Resin	Trade Secre		0.58	mg			13,130
									+S	-S	Silica (amorphous) A	60676-86-0		14.42	mg			327,80
									+S	-S	Silica (amorphous) B	7631-86-9		2.89	mg		ı	65,649
									+S	-S	Metal Hydroxide	Trade Secre		0.11	mg			2,407
									+S	-S	Carbon Black	1333-86-4		0.11	mg			2,407
+1 -1	Lead Frame	+M -M	C194	19.65	mg	+C -C	Supplier		+S	-S	Iron	7439-89-6		0.46	mg			10,495
									+S	-S	Phosphorous	7723-14-0		0.02	mg			368
									+S	-S	Zinc	7440-66-6		0.02	mg			558
									+S	-S	Copper	7440-50-8		18.95	mg			430,70
									+S	-S	Silver	7440-22-4		0.2	mg			4,466
+1 -1	Ероху	+M -M	CRM-1076DS	0.44	mg	+C -C	Supplier		+S	-S	Silver	7440-22-4		0.32	mg		-	7,167
		_							+S	-S	Epoxy Resin	9003-36-5		0.07	mg			1,515
									+S	-S	Diluent	3101-60-8		0.03	mg			758
									+S	-S	Organo Silane	2530-83-9		0.01	mg			303
									+S	-S	Phenol Resin	9003-35-4		0.01	mg			303
+1 -1	Wire	+M -M	CuPdAu	0.1	mg	+C -C	Supplier		+S	-s	Copper	7440-50-8		0.09	mg		[:	2,128
									+S	-s	Palladium	7440-05-3	_	0	mg			36
									+S	-s	Gold	7440-57-5		0	mg			3
+1 -1	Lead Finish	+M -M	Tin	1.67	mg	+C -C	Supplier		+S	-S	Sn	7440-31-5		1.67	mg			37,875